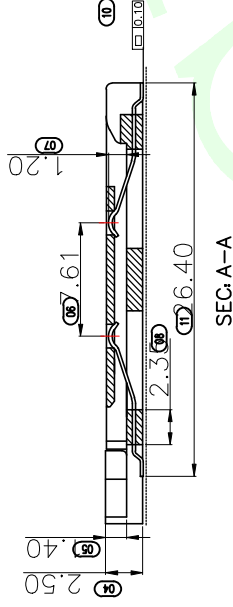
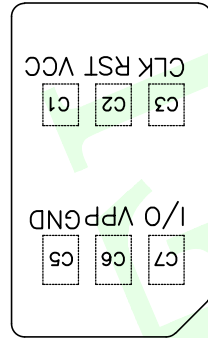


1. Insulator: High temperature thermoplastic
UL94V-0, (BLACK LCP)
2. Photo. Bronze: Plating,
50U" MIN NICKEL UNDERPLATED;
3-8U" GOLD ON THE CONTACT AREA;
100U" TIN PLATING ON SOLDER TAIL

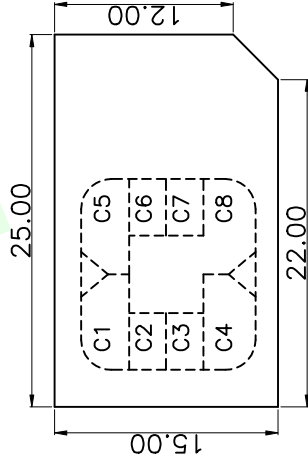
B. Electrical specifications:

- Voltage rating: 10 V AC
- Current rating: 0.5A
- Dielectric strength: 500V AC for 1 minute min
- Insulation resistance: 1000 M ohm
- Contact resistance: 100 mill.ohm max
- Operation temperature: -25° to +95°
- Product withstanding rff low soldering 260° for 10s



08'0"

LCK-MS -207 H250 06- L G
 连晟欣
 LCK
 产品类别
 MS: MINI SIM
 SIM: MICRO SIM
 NANO: NANO SIM
 产品流水料号识别码
 产品高度
 H250: 2.50MM
 06: 6SDIN
 有柱无柱
 Y: 有柱
 W: 无柱
 包装方式
 L: 圆盘
 电鍍鍍絡
 G: gold flash
 GI: 1U
 G3: 3U
 (以此类推)



MEASURE POINT:	(QP)	(TP)	(IP)
QUADRANT POINT			
TANGENCY POINT			
INTERSECTION POINT			
UNLESS OTHERWISE SPECIFIED, TOLERANCE:			
	X.	±0.25	
	X.x	±0.20	
	X.xx	±0.15	
ANGULAR		±3°	

 联晟欣连接器 (深圳) 有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd

DESIGN	Andy	DATE	2014.12.24	TITLE: 2.5H 6PIN SIM CARD SMT		
CHECKED		DATE				
APPROVED		DATE				
PART NO: LCK-MS-207H25006-WLG				REV: 04	SCALE: 1:1	UNIT: mm
DRAWING NO: 102022211				SIZE: A4	SHEET: 1/1	
6				7		